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Correction

## **Correction:** Šejnoha, M. *et al.* Mori-Tanaka Based Estimates of Effective Thermal Conductivity of Various Engineering Materials. *Micromachines* 2011, *2*, 129–149

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We have discovered a mistake in our original derivation related to the definition of the apparent conductivity due to orientation averaging. Equation (23) needs to be corrected to

$$\tilde{s} = \frac{ss}{s}$$
 (23)

and the similar adjustment needs to be made in the two-dimensional case:

$$\tilde{s} = \frac{ss_{2D}}{s_{2D}}$$
(38)

Finally, Equation (39) and the corresponding text becomes: "..., define a certain indicator of the real microstructure  $k_{corr}$ , e.g. as a ratio of the modified and original partial temperature gradient concentration factors

$$k_{\rm corr} = \frac{\widetilde{T} 1_{\rm cir}}{T 1_{\rm cir}} \tag{39}$$

now determined for circular inclusions."

We apologize to readers for any inconvenience.

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